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MOSFET – Power, Dual N-Channel, for 1-Cell Lithium-ion Battery Protection

12 V, 3.2 mΩ, 27 A

EFC6611R

This Power MOSFET features a low on-state resistance. This device is suitable for applications such as power switches of portable machines. Best suited for 1-cell lithium-ion battery applications.

Features

- 2.5 V Drive
- 2 kV ESD HBM
- Common–Drain Type
- ESD Diode-Protected Gate
- Pb-Free, Halogen Free and RoHS Compliance

Applications

• 1-Cell Lithium-ion Battery Charging and Discharging Switch

SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C)

Parameter	Symbol	Value	Unit
Source to Source Voltage	V _{SSS}	12	V
Gate to Source Voltage	V _{GSS}	±8	V
Source Current (DC)	۱ _S	27	А
Source Current (Pulse) PW \leq 100 μ s, Duty Cycle \leq 1%	I _{SP}	100	A
Total Dissipation Surface mounted on ceramic substrate (5000 mm ² x 0.8 mm)	P _T	2.5	W
Junction Temperature	Tj	150	°C
Storage Temperature	T _{stg}	-55 to +150	°C

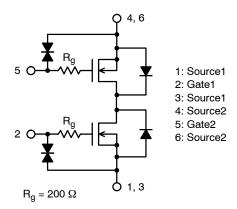
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit
Junction to Ambient Surface mounted on ceramic substrate (5000 mm ² x 0.8 mm)	R_{\thetaJA}	50	°C/W

V _{SSS}	R _{SS(on)} MAX	I _{S MAX}
12 V	3.2 mΩ @ 4.5 V	27 A
	3.2 mΩ @ 4.0 V	
	3.2 mΩ @ 3.8 V	
	4.4 mΩ @ 3.1 V	
	6.3 mΩ @ 2.5 V	

ELECTRICAL CONNECTION N-Channel





MARKING DIAGRAM

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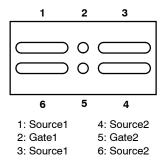
YMZZ

CSP6, 1.77x3.54/ EFCP3517-6DGH-020 CASE 568AL



- Y = Year of Production
- M = Month of Assembly Operation
- ZZ = Assembly Lot Number

PIN CONNECTIONS



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_A = 25° C)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Source to Source Breakdown Voltage	V(_{BR}) _{SSS}	I _S = 1 mA, V _{GS} = 0 V (Test Circuit 1)	12	-	-	V
Zero-Gate Voltage Source Current	I _{SSS}	V_{SS} = 10 V, V_{GS} = 0 V (Test Circuit 1)	-	-	1	μΑ
Gate to Source Leakage Current	I _{GSS}	$V_{GS} = \pm 8 \text{ V}, V_{SS} = 0 \text{ V}$ (Test Circuit 2)	-	-	±1	μΑ
Gate Threshold Voltage	V _{GS} (th)	V _{SS} = 6 V, I _S = 1 mA (Test Circuit 3)	0.5	-	1.3	V
Forward Transconductance	9 _{FS}	V _{SS} = 6 V, I _S = 3 A (Test Circuit 4)	-	19	-	S
Static Source to Source On-State Resistance	R _{SS(on)} 1	$I_S = 5 \text{ A}, V_{GS} = 4.5 \text{ V} \text{ (Test Circuit 5)}$	1.8	2.3	3.2	mΩ
	R _{SS(on)} 2	$I_S = 5 \text{ A}, V_{GS} = 4.0 \text{ V}$ (Test Circuit 5)	1.9	2.4	3.2	mΩ
	R _{SS(on)} 3	$I_S = 5 \text{ A}, V_{GS} = 3.8 \text{ V} \text{ (Test Circuit 5)}$	2.0	2.6	3.2	mΩ
	R _{SS(on)} 4	$I_S = 5 \text{ A}, V_{GS} = 3.1 \text{ V} \text{ (Test Circuit 5)}$	2.1	3.3	4.4	mΩ
	R _{SS(on)} 5	$I_S = 5 \text{ A}, V_{GS} = 2.5 \text{ V}$ (Test Circuit 5)	2.7	4.0	6.3	mΩ
Turn-ON Delay Time	t _{d(on)}	$V_{SS} = 6 V, V_{GS} = 4.5 V, I_{S} = 3 A$	-	80	_	ns
Rise Time	t _r	(Test Circuit 6)	-	570	-	ns
Turn-OFF Delay Time	t _{d(off)}	1	-	38,000	-	ns
Fall Time	t _f	1	-	17,700	-	ns
Total Gate Charge	Qg	V_{SS} = 6 V, V_{GS} = 4.5 V, I_S = 27 A (Test Circuit 7)	-	100	-	nC
Forward Source to Source Voltage	V _{F(S-S)}	I _S = 3 A, V _{GS} = 0 V (Test Circuit 8)	-	0.75	1.2	V

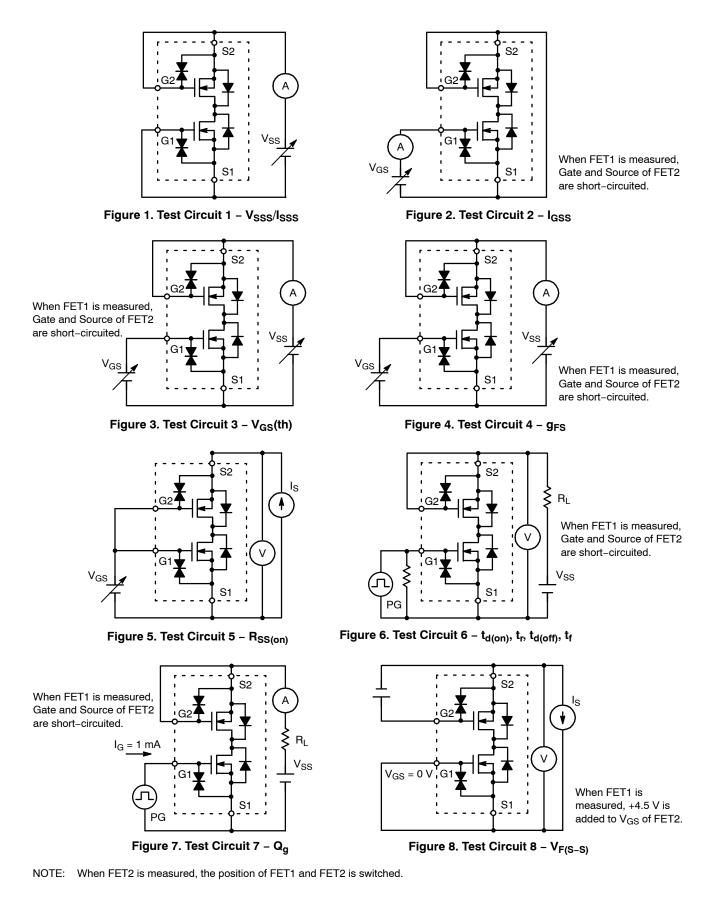
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ORDERING INFORMATION

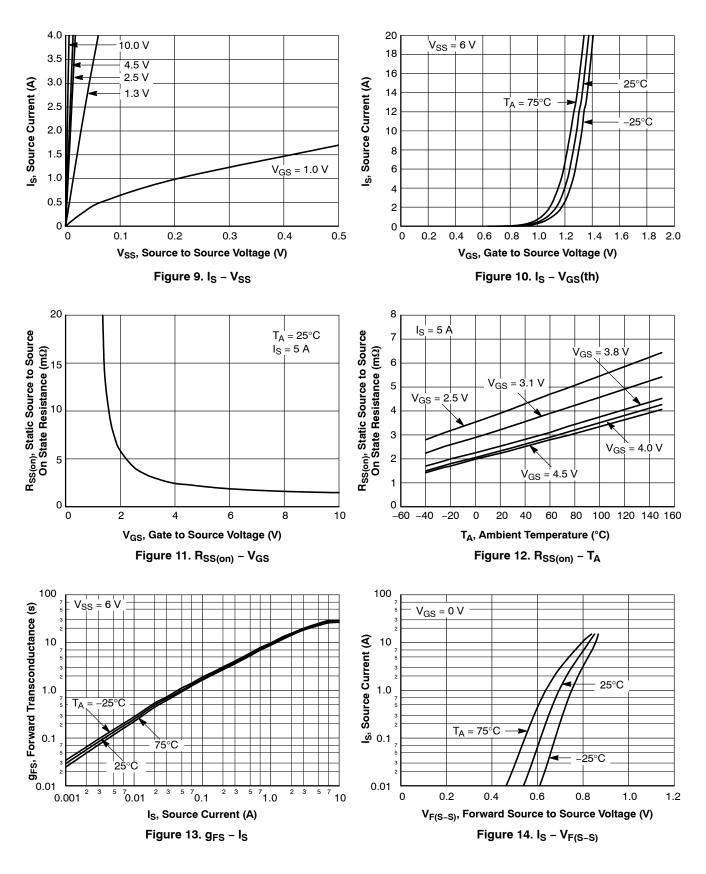
Device	Marking	Package	Shipping (Qty / Packing) †
EFC6611R-TF	ML	CSP6, 1.77 × 3.54 EFCP3517-6DGH-020 (Pb-Free / Halogen Free)	5,000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

TEST CIRCUITS ARE EXAMPLE OF MEASURING FET1 SIDE



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (Continued)

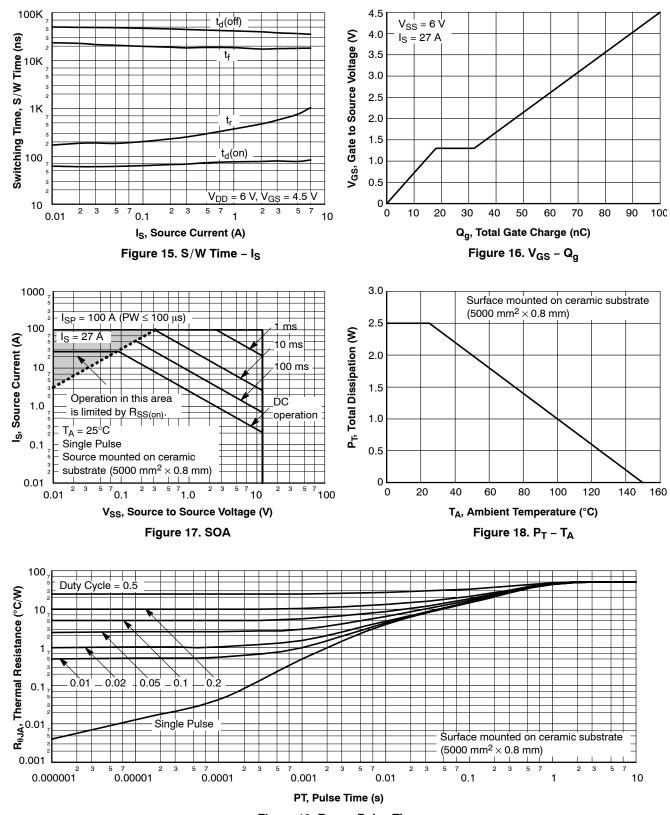
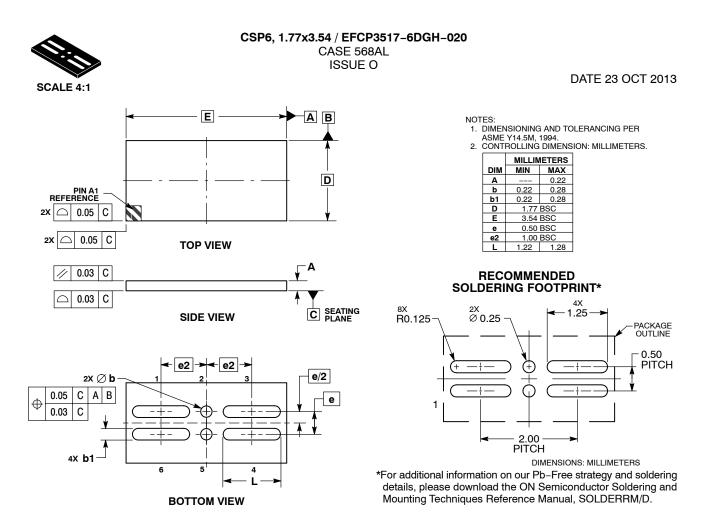


Figure 19. $R_{\theta JA}$ – Pulse Time

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